



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Christopher J. deSimone, Lucian M. Hand, Gi Jeong Kim, Seung Mo Kim, Jin An Lee

Assignee: Amkor and ANAM (Jointly)

Title: Nonexposed Heat Sink For Semiconductor Package

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A. Weir

San Jose, California  
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COMMISSIONER FOR PATENTS  
Washington, D. C. 20231

**CERTIFICATION OF TRANSLATION OF FOREIGN PRIORITY DOCUMENT**  
**UNDER 37 CFR 1.55(a)**

Dear Sir:

Attached hereto as Exhibit A is a translation of Korean patent application 99-13130, which was filed in Korea on April 14, 1999. I, the undersigned, certify that the document attached at Exhibit A is an accurate translation of Korean patent application 99-13130.

Dated: January 17, 2002

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